

ShenZhen ChipSourceTek Technology Co., Ltd.



ME2108

### PFM Step-up DC/DC Converter, ME2108 Series

### **General Description**

ME2108 Series is a PFM Step-up DC/DC converter IC with low supply current by CMOS process. High frequency noise that occurs during switching is reduced by using advanced circuit designed, output voltage is programmable in 0.1V steps between 2.0~7.0V and maximum frequency is 180KHz(TYP.). A low ripple, high efficiency step-up DC/DC converter can be constructed of ME2108Xxx with only three external components. Also available is a CE(chip enable) function that reduce power dissipation During shut-down mode. ME2108Xxx is suitable for use with battery-powered instruments with low noise and low supply current.

#### **Features**

- Low ripple and low noise
- Operating voltage range: 0.9V~6.5V
- Output voltage range: 2.0V~7.0V(step 0.1V)
- Output voltage accuracy: ±2.5%
- Output Current: If V<sub>IN</sub>=3.0V and V<sub>OUT</sub>=5.0V,then I<sub>OUT</sub>=400mA
- Low start voltage: ≤0.9V(at I<sub>OUT</sub> =1mA)
- Maximum oscillator frequency: 180KHz(TYP.)
- High Efficiency: 85%(TYP.)

### **Typical Application**

- Power source for battery-powered equipment
- Power source for wireless mouse, wireless keyboard, toys, cameras, camcorders, VCRs, PDAs, and hand-held communication equipment
- Power source for appliances which require higher cell voltage than that of batteries used in the appliances

### **Package**

- 3-pin: SOT23-3、SOT89-3、TO92
- 5-pin: SOT23-5

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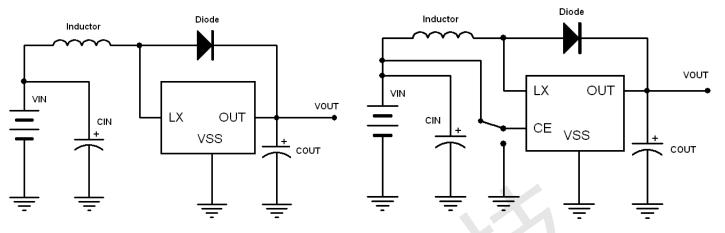




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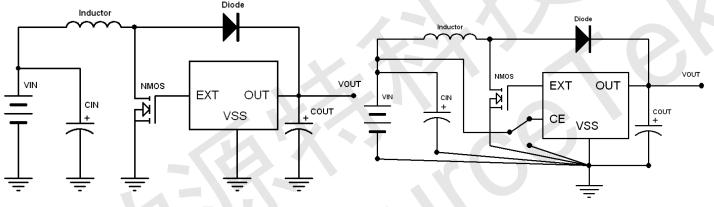
### **Typical Applications**

## ME2108



For use build in transistor

For use chip enable



For use external transistor

For use external transistor&chip enable

#### Components:

Inductor: 33uH(Sumida) Diode: IN5817, IN5819

Capacitor: 47uF/16V(Tantalum Capacitor)

Transistor: 2SD1628G、2SD3279

NMOS: MEM2302、AAT9460、XP151、XP161

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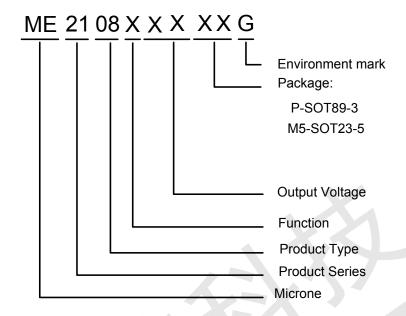
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## Selection Guide ME2108



Product series	Switch Transistor	CE Function	Featutes	Voltage	Package
ME2108A28PG	Build in Transistor	No	Lx	2.8	SOT89-3
ME2108A30M3G	Build in Transistor	No	Lx	3.0	SOT23-3
ME2108A33TG	Build in Transistor	No	Lx	3.3	TO-92
ME2108B33M3G	External Transistor	No	Ext	3.3	SOT23-3
ME2108C36M5G	Build in Transistor	Yes	Lx	3.6	SOT23-5
ME2108D50M5G	External Transistor	Yes	Ext	5.0	SOT23-5
ME2108F33M5G	External Transistor	Yes	Ext	3.3	SOT23-5

**NOTE:** At present ,there are five kinds of voltage value:

2.7V、2.8V、3.0V、3.3V、3.6V、4.0V、5.0V、5.6V。

If you need other voltage and package, please contact our sales staff.

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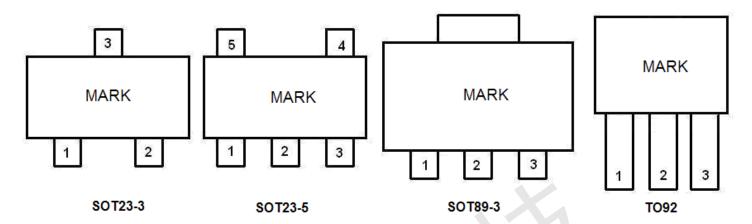




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### **Pin Configuration**

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#### **ME2108AXX**

	PIN Number		Din Name	Function
SOT23-3	SOT89-3	TO92	Pin Name Function	Function
1	1	1	Vss	Ground
3	2	3	Vout	Output voltage monitor, IC internal power supply
2	3	2	Lx	Switch

#### **ME2108BXX**

PIN Number		Pin Name	Function	
SOT23-3	SOT89-3	Pili Naille	Function	
1	1	Vss	Ground	
3	2	Vout	Output voltage monitor, IC internal power supply	
2	3	Ext	External switch transistor drive	

#### **ME2108CXX**

PIN Num	ber	Din Name	Function
SOT23-5	SOT89-5	Pin Name	Function
4	5	Vss	Ground
2	2	Vout	Output voltage monitor, IC internal power supply
5	4	Lx	Switch
1	3	CE	Chip enable
3	1	NC	NC

#### ME2108DXX

PIN Number	Din Nama	Franction
SOT23-5	Pin Name	Function
4	Vss	Ground
2	Vout	Output voltage monitor, IC internal power supply
5	Ext	External switch transistor drive
1	CE	Chip enable
3	NC	NC

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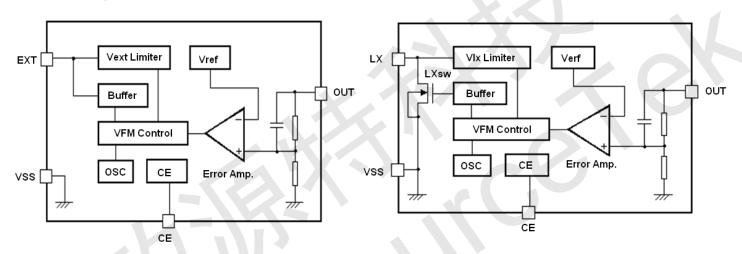
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#### ME2108F

## ME2108

PIN Number	Pin Name	Function
SOT23-5	Pili Naille	Function
1	FB	Feed Back
2	Vdd	Output voltage monitor, IC internal power supply
3	NC	NC
4	Vss	Ground
5	EXT	External switch transistor drive

### **Block Diagram**



### **Absolute Maximum Ratings**

PARAMETER		SYMBAL	RATINGS	UNITS
V <sub>IN</sub> Input Voltage	9	V <sub>IN</sub>	6.5	V
Lx Pin voltage		$V_{LX}$	6.5	V
EXT Pin voltage		$V_{EXT}$	-0.3~Vout+0.3	V
CE Pin voltage	е	V <sub>CE</sub>	-0.3~Vout+0.3	V
Lx Pin current		I <sub>LX</sub>	600	mA
EXT Pin current	į	I <sub>EXT</sub>	±30	mA
Vdd input voltag	е	$V_{dd}$	6.5	V
Continuous Total Power	SOT23	Pd	300	mW
Dissipation	SOT89	Pd	500	mW
TO92		Pd	500	mW
Operating Ambient Temperature		T <sub>Opr</sub>	-25~+85	$^{\circ}$
Storage Temperature		T <sub>stg</sub>	-40~+125	$^{\circ}$
Soldering temperature a	and time	T <sub>solder</sub>	260℃, 10s	

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5/14





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### **Electrical Characteristics**

ME2108

Measuring conditions: Unless otherwise specified ,  $V_{IN}$ =Vout $\times$ 0.6,  $V_{SS}$ =0V,  $I_{OUT}$ =10mA,  $T_{opt}$ =25  $^{\circ}$ C  $_{\circ}$  ME2108Axx/Cxx Fosc=180kHz

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
V <sub>OUT</sub>	Output Voltage		Vout× 0.975	Vout	Vout× 1.025	V
V <sub>start</sub>	Oscillation Start-up Voltage	I <sub>OUT</sub> =1mA, V <sub>IN</sub> : 0→2V		0.8	0.9	V
V <sub>hold</sub>	Oscillation Hold Voltage	$I_{OUT}$ =1mA, $V_{IN}$ : 2 $\rightarrow$ 0V		0.45		V
I <sub>DD1</sub>	Supply Current 1	No external component Vout=Vout×0.95,		50		μA
I <sub>DD2</sub>	Supply Current 2	Vout=Vout+0.5V		9		μA
I <sub>LX</sub>	Lx Switching Current	$V_{LX}$ =0.4V, Vout=Vout×0.95		360		mA
I <sub>LXleak</sub>	Lx Leakage Current	Vout=V <sub>LX</sub> =6V			0.5	μA
F <sub>osc</sub>	Oscillation Frequency	Vout=set Vout×0.95		180		kHz
Maxdty	Duty Ratio	on(V <sub>LX</sub> "L")side		84		%
EFFI	Efficiency			85		%

#### ME2108Bxx/Dxx Fosc=180kHz

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
V <sub>OUT</sub>	Output Voltage		Vout× 0.975	Vout	Vout× 1.025	V
V <sub>start</sub>	Oscillation Start-up Voltage	$I_{OUT}$ =1mA, $V_{IN}$ : 0 $\rightarrow$ 2V		0.8	0.9	V
$V_{hold}$	Oscillation Hold Voltage	$I_{OUT}$ =1mA, $V_{IN}$ : 2 $\rightarrow$ 0V		0.45		V
I <sub>DD1</sub>	Supply Current 1	No external component Vout=Vout×0.95,		80		μΑ
I <sub>DD2</sub>	Supply Current 2	Vout=Vout+0.5V		12		μA
I <sub>LX</sub>	Lx Switching Current	$V_{LX}$ =0.4V, Vout=Vout $\times$ 0.95		360		mA
I <sub>LXleak</sub>	Lx Leakage Current	Vout=V <sub>LX</sub> =6V			0.5	μA
F <sub>osc</sub>	Oscillation Frequency	Vout=set Vout×0.95		180		kHz
Maxdty	Duty Ratio	on(V <sub>LX</sub> "L")side		84		%
EFFI	Efficiency			85		%

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**ME2108F** VFB=3.3V, Fosc=180kHz

### ME2108

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
V <sub>FB</sub>	Output Feedback Voltage		3.22	3.3	3.38	V
V <sub>start</sub>	Oscillation Start-up Voltage	I <sub>OUT</sub> =1mA, V <sub>IN</sub> : 0→2V		0.8	0.9	V
$V_{hold}$	Oscillation Hold Voltage	I <sub>OUT</sub> =1mA, V <sub>IN</sub> : 2→0V		0.45		V
I <sub>DD1</sub>	Supply Current 1	No external component Vout=Vout×0.95,	,	80		μΑ
I <sub>DD2</sub>	Supply Current 2	Vout=Vout+0.5V		10		μA
I <sub>LX</sub>	Lx Switching Current	$V_{LX}$ =0.4V, Vout=Vout $\times$ 0.95		360		mA
I <sub>LXleak</sub>	Lx Leakage Current	Vout=V <sub>LX</sub> =6V			0.5	μA
F <sub>osc</sub>	Oscillation Frequency	Vout=set Vout × 0.95		180		kHz
Maxdty	Duty Ratio	on(V <sub>LX</sub> "L")side		84		%
EFFI	Efficiency		<del>-</del>	85		%

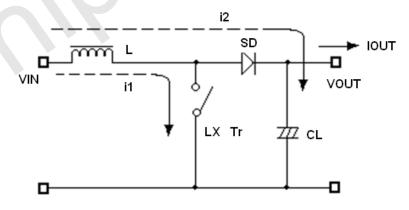
Note: 1. Diode use Schottky diode such as IN5817 or IN5819 (forward voltage drop:0.2V)

2. Inductor:  $33\mu H (r<0.5\Omega)$ 

3、Capacitor: Tantalum type 100μF

### **Operation Description**

ME2108 step-up DC/DC converter charges energy in the inductor when Lx Transistor is on, and discharges the energy with the addition of the energy from input power source thereto, so that a higher output voltage than the input voltage is obtained. Following is the operation diagram.



Switching DC/DC Step up Converter operating process

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Selection of Peripheral Components and Application Notes

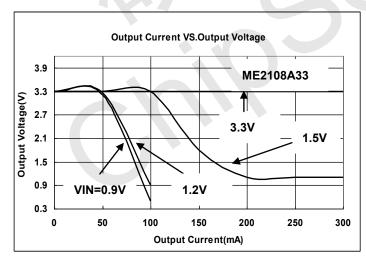
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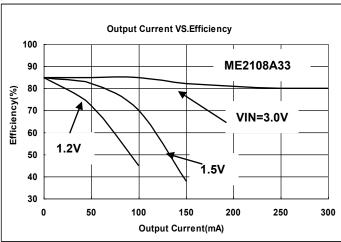
- Power source for battery-powered equipment
- Power source for wireless mouse, wireless keyboard, toys, cameras, camcorders, VCRs, PDAs, and hand-held communication equipment
- > Power source for appliances which require higher cell voltage than that of batteries used in the appliances
- Peripheral components should be selected carefully because they are greatly affect the performances of ME2108:
  - ♦ Use capacitor with a capacity of 10µF or more ( too small capacity will lead to high output ripple), and with good frequency characteristics ( it is better to use Tantalum type). Besides, it is recommended the use of a capacitor with an allowable voltage which is at least three times the output set voltage. This is because there may be the case where a spike-shaped high voltage is generated by the inductor when Lx transistor is turned OFF.
  - Choose such an inductor that has sufficiently small d.c. resistance and large allowable current, and hardly reaches magnetic saturation. When the inductance value of the inductor is small, there may be the case where ILX exceeds the absolute maximum ratings at the maximum load.
  - Use a diode of a Schottky type with high switching speed.
- PCB Layout:
  - Set external components as close as possible to the IC and minimize the connection between the components and the IC. In particular, when an external component is connected to VOUT Pin, make minimum connection with the capacitor.
  - ♦ Make Vss pin sufficient grounding, otherwise, the zero level within IC will varied with the switching current. This may result in unstable operation of IC.

### **Type Characteristics**

(1) Output CurrentVS.Output Voltage (Ta = 25 °C)

(2) Output Current VS. Efficiency (**Ta = 25** °**C**)





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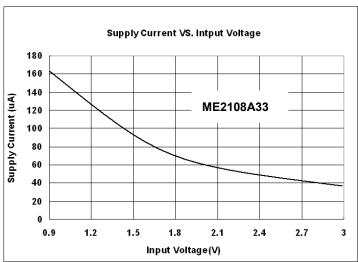


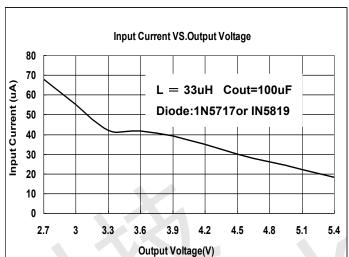


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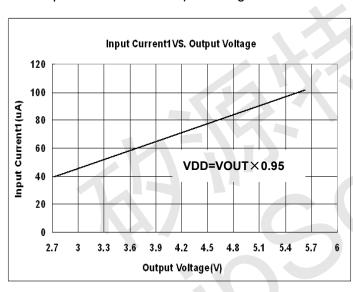
(4) Input Current VS. Output Voltage (Ta = 25 °C)

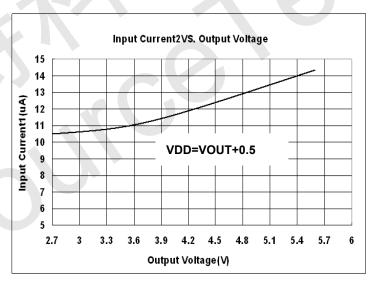
(3) Supply Current VS. Input Voltage (**Ta = 25 °C**)



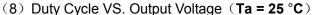


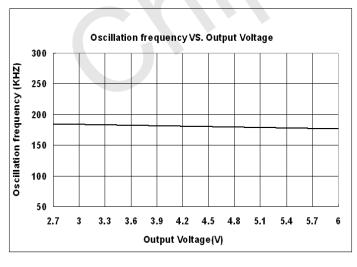
(5) Input Current1VS. Output Voltage (Ta = 25 °C) (6) Input Current2VS. Output Voltage (Ta = 25 °C)

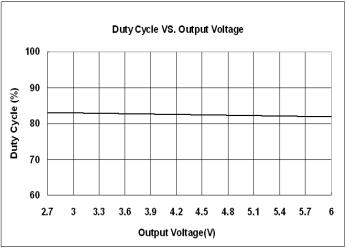




(7) Oscillation frequency VS. Output Voltage







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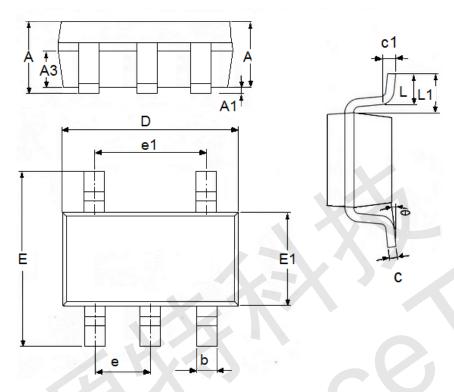




### **Packaging Information**

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● SOT23-5



DIM	Millim	neters	Inches		
DIM	Min	Max	Min	Max	
А	1.05	1.45	0.0413	0.0571	
A1	0	0.15	0	0.0059	
A2	0.9	1.3	0.0354	0.0512	
A3	0.6	0.7	0.0236	0.0276	
b	0.25	0.5	0.0098	0.0197	
С	0.1	0.23	0.0039	0.1228	
D	2.82	3.05	0.111	0.1201	
e1	1.8	2.0	0.0709	0.0787	
Е	2.6	3.05	0.1024	0.1201	
E1	1.5	1.75	0.0591	0.0689	
е	0.85	1.05	0.0335	0.0413	
L	0.25	0.6	0.0098	0.0236	
L1	0.59	0.6	0.0232	0.0236	
θ	0	8°	0	8°	
c1	0.2	0.25	0.0079	0.0098	

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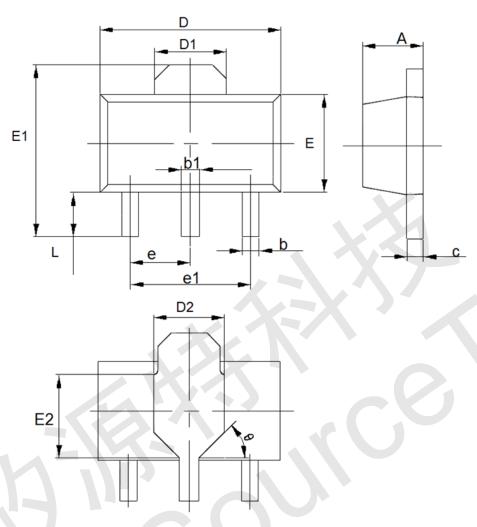




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### ● SOT89-3



DIM	Millim	neters	Inc	ches	
DIM	Min	Max	Min	Max	
Α	1.4	1.6	0.0551	0.063	
b	0.32	0.52	0.0126	0.0205	
b1	0.4	0.58	0.0157	0.0228	
С	0.35	0.45	0.0138	0.01772	
D	4.4	4.6	0.1732	0.1811	
D1	1.55	1.75	0.061	0.0689	
D2	1.75	REF	0.0689REF		
e1	2.95	3.05	0.1161	0.1201	
Е	2.3	2.6	0.0906	0.1023	
E1	3.94	4.4	0.1551	0.1732	
E2	1.9	1.9REF		18REF	
е	1.5	ΓΥΡ	0.0591TYP		
L	0.8	1.2	0.0315	0.0472	
θ	4:	5°	45°		

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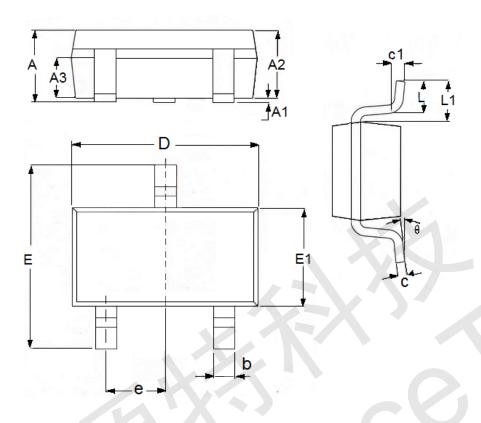




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#### ● SOT23-3



DIM	Millimeters		Inches	
	Min	Max	Min	Max
Α	1.05	1.45	0.0413	0.0571
A1	0	0.15	0	0.0059
A2	0.9	1.3	0.0354	0.0512
A3	0.6	0.7	0.0236	0.0276
b	0.25	0.5	0.0098	0.0197
С	0.1	0.25	0.0039	0.0098
D	2.82	3.05	0.111	0.1201
Е	2.6	3.05	0.1024	0.1201
E1	1.5	1.75	0.0591	0.0689
е	0.85	1.05	0.0335	0.0413
L	0.25	0.6	0.0098	0.0236
L1	0.59	0.6	0.0232	0.0236
θ	0	8°	0	8°
c1	0.2	0.25	0.0079	0.0098

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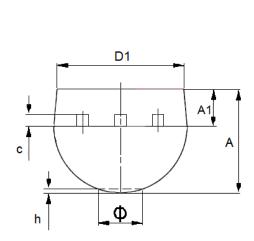


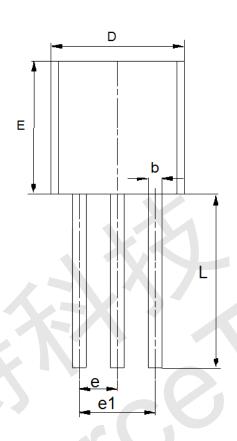


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● TO92





DIM	Millimeters		Inches			
	Min	Max	Min	Max		
Α	3.3	3.7	0.1299	0.1457		
A1	1.1	1.4	0.0433	0.0551		
b	0.38	0.55	0.015	0.0217		
С	0.36	0.51	0.0142	0.0201		
D	4.3	4.7	0.1693	0.185		
D1	3.43	_	0.135	_		
Е	4.3	4.7	0.1693	0.185		
е	2.4	2.7	0.0945	0.1063		
e1	2.44	2.64	0.0961	0.1039		
L	14.1	14.5	0.5551	0.5709		
h	0	0.38	0	0.015		
Ф	_	1.6	_	0.063		

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